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September 2015



#### Features

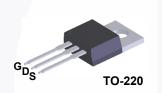
- Typ. R<sub>DS(on)</sub> = 188 mΩ
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 78 nC)
- Low E<sub>oss</sub> (Typ. 7.5 uJ @ 400 V)
- Low Effective Output Capacitance (Typ. C<sub>oss(eff.)</sub> = 304 pF)
- 100% Avalanche Tested
- RoHS Compliant
- · ESD Improved Capability

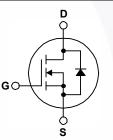
#### Applications

- AC-DC Power Supply
- LED Lighting

#### Description

SuperFET<sup>®</sup> II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.





#### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

Symbol		Parameter	FCP220N80	Unit		
V <sub>DSS</sub>	Drain to Source Voltage	e Voltage			V	
V <sub>GSS</sub>	Cata to Course Valtage	- DC		±20	V	
	Gate to Source Voltage	- AC	(f >1 Hz)	±30	V	
ID	Droin Current	- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)		23	Α	
	Drain Current	- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)		14.6	— A	
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	57	A	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)			645	mJ	
I <sub>AR</sub>	Avalanche Current (Note 1)			4.6	A	
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)			27.8	mJ	
dv/dt	MOSFET dv/dt	100	V/ns			
	Peak Diode Recovery dv/dt (Note 3)				20	
P <sub>D</sub>	Dower Discinction	(T <sub>C</sub> = 25°C)	(T <sub>C</sub> = 25°C)		W	
	Power Dissipation	- Derate Above 25°C	- Derate Above 25°C			
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

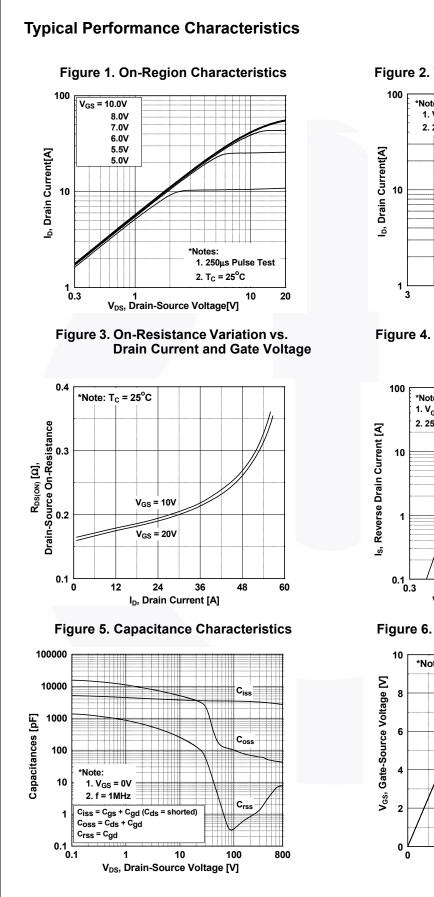
#### **Thermal Characteristics**

Symbol	Parameter	FCP220N80	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.45	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	°C/W

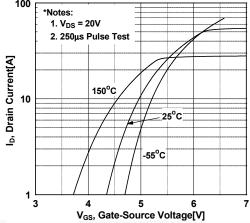
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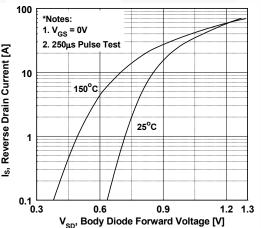
	umber	Top Mark	Package	Packing Method	Reel Size	ə 1	ape Width	ı Qu	antity
		TO-220	• •			N/A	50	50 units	
Electrica	I Chara	cteristics T <sub>C</sub> = 25 <sup>c</sup>	C unless oth	erwise noted.		·			
Symbol	Parameter			Test Conditions		Min.	Тур.	Max.	Unit
Off Charac	teristics				k		1		
BV <sub>DSS</sub>		ource Breakdown Voltag	ie Vo	$a = 0 V l_{\rm D} = 1 \mathrm{mA} \mathrm{T}_{\rm L}$	= 25°C	800	_	-	V
ABV <sub>DSS</sub>	Breakdown Voltage Temperature			$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 1 \text{ mA}, \text{ T}_{J} = 25^{\circ}\text{C}$		000	0.0		
$\Delta T_{J}$	Coefficient		_	$I_D = 1 \text{ mA}$ , Referenced to $25^{\circ}$ C		-	0.8	-	V/ºC
I <sub>DSS</sub>	Zero Gate Voltage Drain Current			V <sub>DS</sub> = 800 V, V <sub>GS</sub> = 0 V		-	-	25	μA
				$_{\rm S}$ = 640 V, T <sub>C</sub> = 125°C	;	-	-	250	
GSS	Gate to Body Leakage Current		V <sub>G</sub>	$_{\rm S}$ = ±20 V, V <sub>DS</sub> = 0 V		-	-	±100	nA
On Charac	teristics								
V <sub>GS(th)</sub>	Gate Thre	shold Voltage	VG	<sub>S</sub> = V <sub>DS</sub> , I <sub>D</sub> = 2.3 mA		2.5	-	4.5	V
R <sub>DS(on)</sub>	Static Drai	n to Source On Resista	-	<sub>S</sub> = 10 V, I <sub>D</sub> = 11.5 A		-	188	220	mΩ
ĴFS	Forward T	ransconductance	VD	<sub>S</sub> = 20 V, I <sub>D</sub> = 11.5 A		-	25	-	S
Dynamic C	haracteri	istics							
C <sub>iss</sub>	Input Capa			V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V, f = 1 MHz		-	3430	4560	pF
Coss	Output Ca		-			-	100	135	pF
C <sub>rss</sub>		ransfer Capacitance	f =				0.3	-	pF
C <sub>oss</sub>	Output Capacitance		VD	V <sub>DS</sub> = 480 V, V <sub>GS</sub> = 0 V, f = 1 MHz			49	-	pF
Coss(eff.)	Effective C	Output Capacitance		$_{\rm S}$ = 0 V to 480 V, V <sub>GS</sub>		-	304	-	pF
Q <sub>g(tot)</sub>	Total Gate	Charge at 10V	Vn	<sub>S</sub> = 640 V, I <sub>D</sub> = 23 A,		-	78	105	nC
Q <sub>gs</sub>	Gate to Sc	ource Gate Charge		$V_{GS} = 10 V$		-	16	-	nC
Q <sub>gd</sub>	Gate to Dr	ain "Miller" Charge			(Note 4)	-	28	-	nC
ESR	Equivalent	Series Resistance	f =	1 MHz		-	0.78	-	Ω
Switching	Characte	ristics							
d(on)	Turn-On D	elay Time				-	27	64	ns
r	Turn-On R	ise Time		$V_{DD}$ = 400 V, I <sub>D</sub> = 23 A, V <sub>GS</sub> = 10 V, R <sub>g</sub> = 4.7 Ω (Note 4)		-	19	48	ns
d(off)	Turn-Off D	elay Time	V <sub>G</sub>			-	75	160	ns
f	Turn-Off Fa	all Time				/-	2.6	15	ns
Drain-Sou	rce Diode	Characteristics							
s	Maximum Continuous Drain to Source Diode Forward Current					-	-	23	Α
SM	Maximum Pulsed Drain to Source Diode		Diode Forwa	Forward Current		-	-	57	Α
√ <sub>SD</sub>	Drain to So	ource Diode Forward Vo	Itage V <sub>G</sub>	<sub>S</sub> = 0 V, I <sub>SD</sub> = 23 A		-	-	1.2	V
'n	Reverse R	ecovery Time	V <sub>G</sub>	<sub>S</sub> = 0 V, I <sub>SD</sub> = 23 A,		-	560	-	ns
ე <sub>rr</sub>	Reverse R	ecovery Charge	dl <sub>F</sub>	dl <sub>F</sub> /dt = 100 A/μs		-	14	-	μC



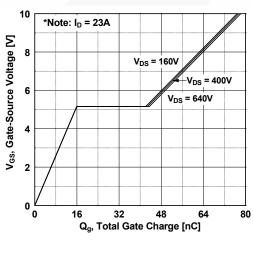
#### Figure 2. Transfer Characteristics



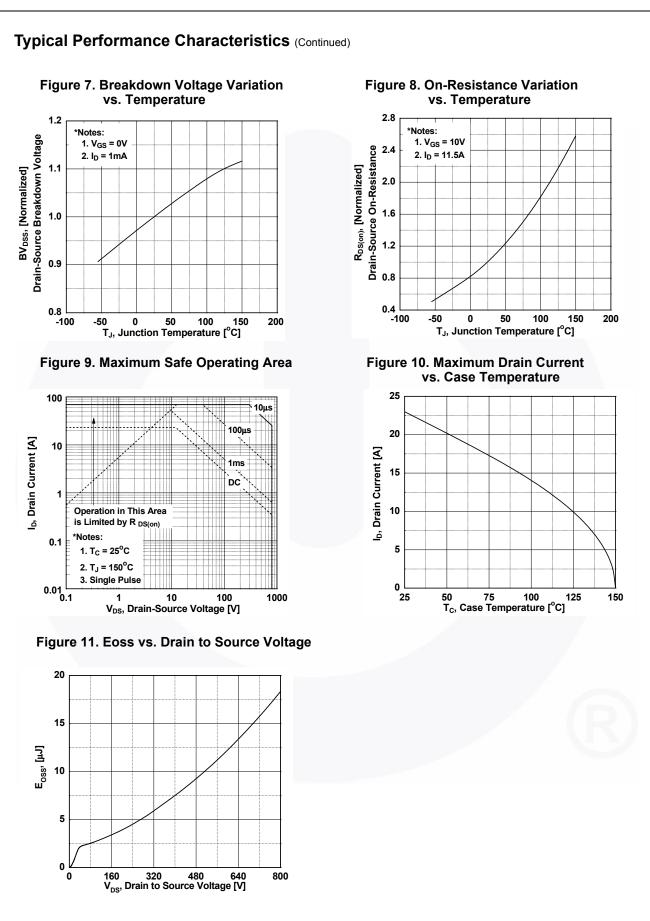
#### Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature



#### **Figure 6. Gate Charge Characteristics**

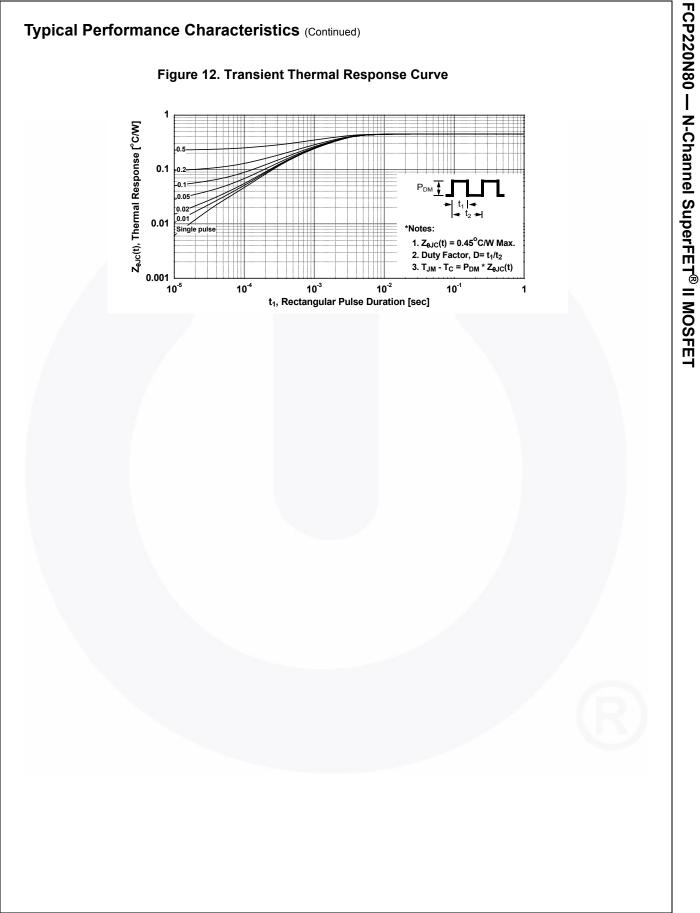


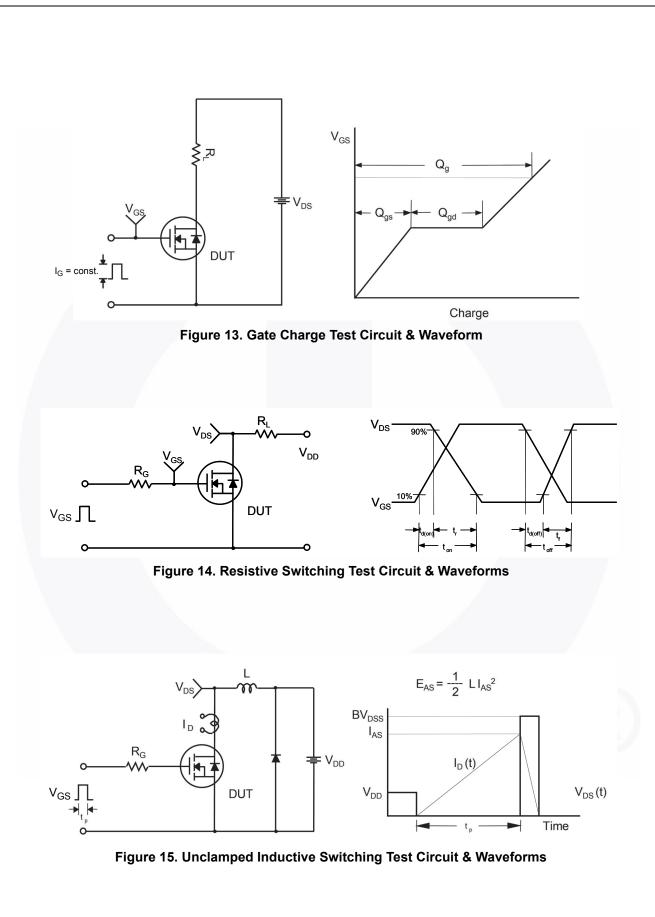




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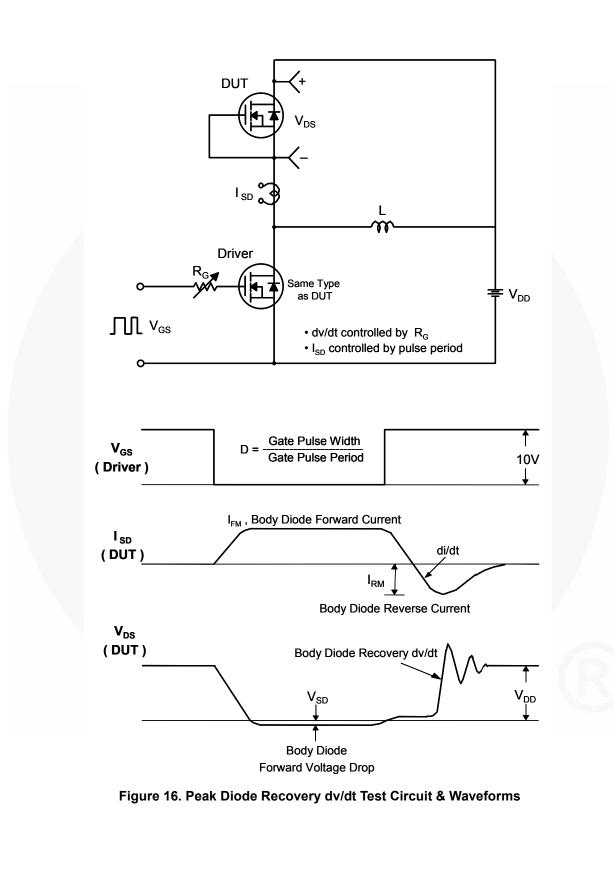
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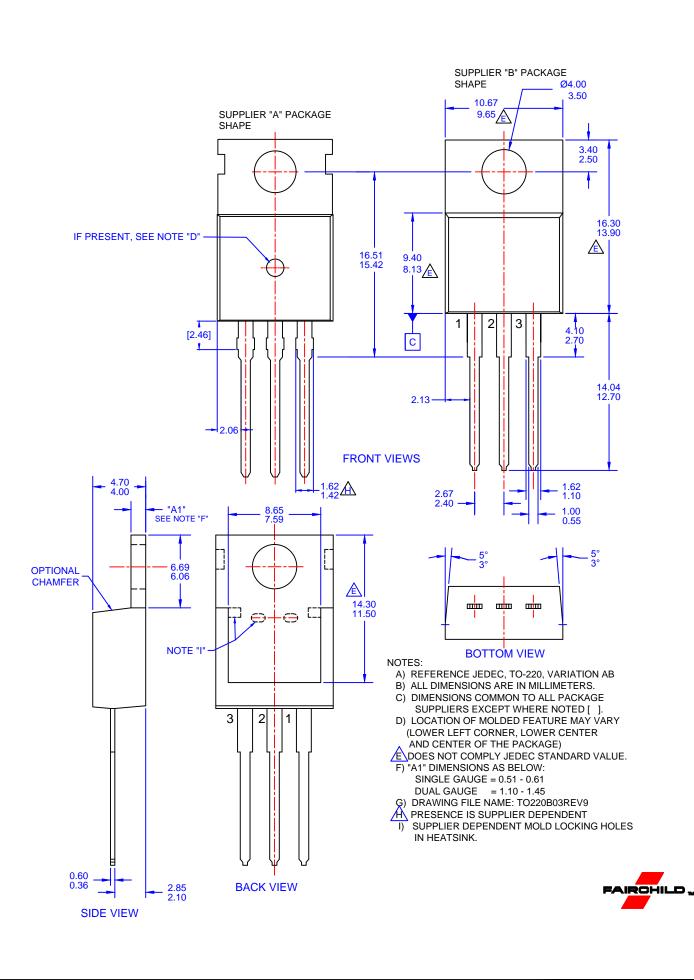




FCP220N80 — N-Channel SuperFET<sup>®</sup> II MOSFET

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